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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









#### **DATASHEET**

# SMD • TOP View LEDs EAPL3527RA4

**PRELIMINARY** 



#### **Features**

- P-LCC-2 package.
- · White package.
- · Optical indicator.
- Colorless clear window.
- Wide viewing angle.
- Suitable for vapor-phase reflow, Infrared reflow and wave solder processes.
- Computable with automatic placement equipment.
- Available on tape and reel (8mm Tape).
- Pb-free
- The product itself will remain within RoHS compliant version.

#### **Description**

This series is available in soft orange, green, blue and yellow. Due to the package design, the LED has wide viewing angle and optimized light coupling by inter reflector. This feature makes ideal for light pipe application. The low current requirement makes this device ideal for portable equipment or any other application where power is at a premium.

#### **Applications**

- Automotive: backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- Light pipe application.
- · General use.



#### **Device Selection Guide**

Chip Materials	Emitted Color	Resin Color
AlGalnP	Brilliant Red	Water Clear

#### Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit
Reverse Voltage	$V_{R}$	5	V
Forward Current	I <sub>F</sub>	50	mA
Peak Forward Current (Duty 1/10 @1KHz)	I <sub>FP</sub>	100	mA
Power Dissipation	Pd	120	mW
Junction Temperature	T <sub>j</sub>	115	$^{\circ}$
Operating Temperature	$T_{opr}$	-40 ~ +85	$^{\circ}$ C
Storage Temperature	Tstg	-40 ~ +90	$^{\circ}$
The second Descriptions	Rth <sub>J-A</sub>	500	K/W
Thermal Resistance	Rth <sub>J-S</sub>	300	K/W
ESD	ESD <sub>HBM</sub>	2000	V
(Classification acc. AEC Q101)	ESD <sub>MM</sub>	200	V
Soldering Temperature	T <sub>sol</sub>	Reflow Soldering : 2 Hand Soldering : 35	



#### **Electro-Optical Characteristics (Ta=25℃)**

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	lv	360		900	mcd	I <sub>F</sub> =20mA
Viewing Angle	$2\theta_{1/2}$		120		deg	I <sub>F</sub> =20mA
Peak Wavelength	λр		632		nm	I <sub>F</sub> =20mA
Dominant Wavelength	λd	621		631	nm	I <sub>F</sub> =20mA
Spectrum Radiation Bandwidth	Δλ		20		nm	I <sub>F</sub> =20mA
Forward Voltage	$V_{F}$	1.75		2.35	V	I <sub>F</sub> =20mA
Reverse Current	I <sub>R</sub>			50	μΑ	$V_R=5V$

1. Tolerance of Luminous Intensity: ±11%

Tolerance of Dominant Wavelength: ±1nm
Tolerance of Forward Voltage: ±0.1V



#### **Bin Range of Luminous Intensity**

Bin Code	Min.	Max.	Unit	Condition
T2	360	450		
U1	450	565		
U2	565	715	mcd	$I_F = 20mA$
V1	715	900		

Note:

Tolerance of Luminous Intensity: ±11%

#### **Bin Range of Dominant Wavelength**

Bin Code	Min.	Max.	Unit	Condition
FF1	621	626		J 00 A
FF2	626	631	— nm	I <sub>F</sub> =20mA

Note:

Tolerance of Dominant Wavelength: ±1nm

#### **Bin Range of Forward Voltage**

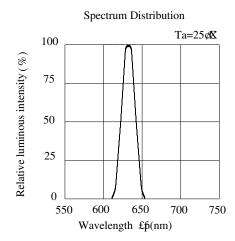
Bin Code	Min.	Max.	Unit	Condition
0	1.75	1.95		
1	1.95	2.15	V	$I_F = 20 \text{mA}$
2	2.15	2.35		•

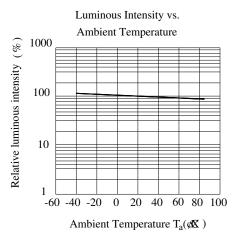
Note:

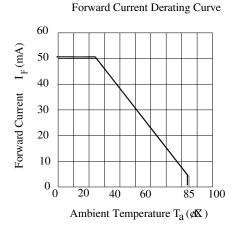
Tolerance of Forward Voltage: ±0.1V

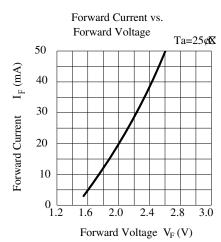


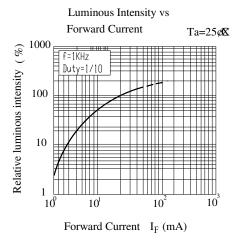
#### **Typical Electro-Optical Characteristics Curves**

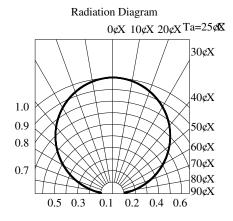






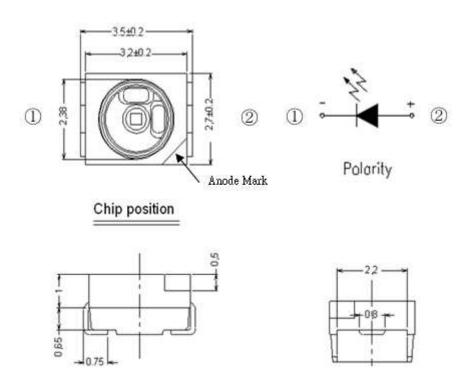








### **Package Dimension**



Note: Tolerances unless mentioned ±0.1mm. Unit = mm



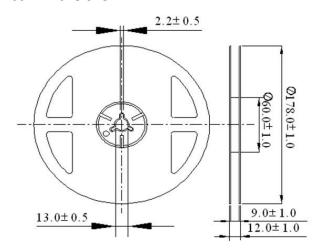
#### **Moisture Resistant Packing Materials**

#### **Label Explanation**



- CPN: Customer's Product Number
- P/N: Product Number
- QTY: Packing Quantity
- CAT: Luminous Intensity Rank
- HUE: Dom. Wavelength RankREF: Forward Voltage Rank
- · LOT No: Lot Number

#### **Reel Dimensions**



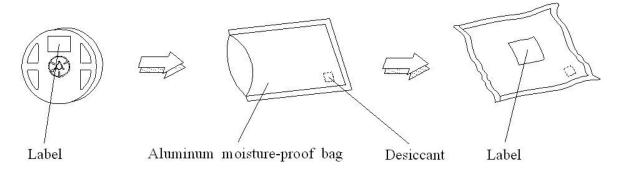
#### Carrier Tape Dimensions: Loaded Quantity 2000 pcs Per Reel

# 

Note: Tolerances unless mentioned ±0.1mm. Unit = mm



#### **Moisture Resistant Packing Process**

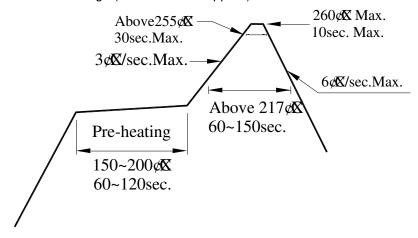


Note: Tolerances unless mentioned ±0.1mm. Unit = mm

#### **Precautions for Use**

#### 1. Over-current-proof

1.1 Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change ( Burn out will happen ).



#### 2. Storage

- 2.1 Moisture proof bag should only be opened immediately prior to usage.
- 2.2 Environment should be less than  $30^{\circ}$  and  $60^{\circ}$  RH when moisture proof bag is opened.
- 2.3 After opening the package MSL Conditions stated on page 1 of this spec should not be exceeded.
- 2.4 If the moisture sensitivity card indicates higher than acceptable moisture, the component should be baked at min. 60 deg + -5 deg for 24 hours.

#### 3. Soldering Condition

- 3.1 Pb-free solder temperature profile
- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

#### 4. Soldering Iron



than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

#### 5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.

#### **Application Restrictions**

High reliability applications such as military/aerospace, automotive safety/security systems, and medical equipment may require different product. If you have any concerns, please contact Everlight before using this product in your application. This specification guarantees the quality and performance of the product as an individual component. Do not use this product beyond the specification described in this document.

#### **Revision History**

Rev.	Modified date	File modified contents
1	2014/4/30	New Spec